







UEC5, UCC8 SERIES

RUGGED MICRO FLYOVER SOCKET SYSTEM

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?UEC5

Insulator Material: Black LCP Contact Material: BeCu Plating: Au or Sn over 50 μ" (1.27 μm) Ni Current Rating: 1.8 A per pin (2 pins powered) Operating Temp Range: -55° C to +125° C ROHS Compliant: Yes

PROCESSING

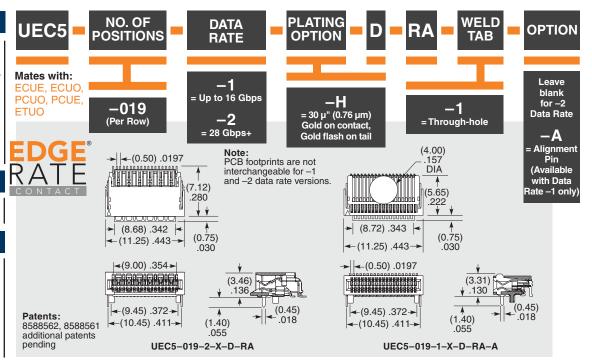
Lead-Free Solderable: Yes SMT Lead Coplanarity: (0.10 mm) .004" max

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



Note: Some lengths, styles and options are non-standard non-returnable.



SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?UCC8

Insulator Material: Black LCP Contact Material: BeCu Weld Tab: Copper Alloy Plating: Au or Sn over 50 µ" (1.27 µm) Ni Current Rating: 2.6 A per pin (1 pin powered) Operating Temp Range: -55° C to +125° C RoHS Compliant: Yes

PROCESSING

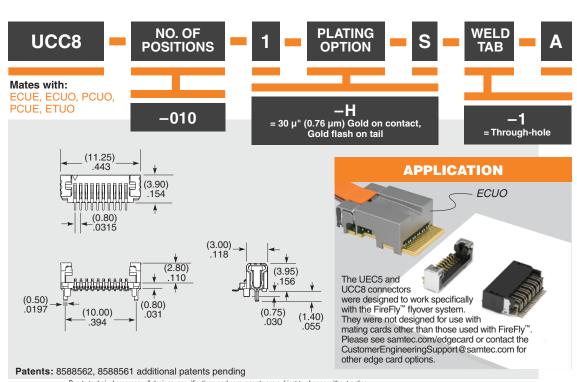
Lead-Free Solderable: Yes SMT Lead Coplanarity: (0.10 mm) .004" max

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



Note: Some lengths, styles and options are non-standard, non-returnable.



Due to technical progress, all designs, specifications and components are subject to change without notice